

between 0.5 and 5 micrometers.

31. (New) The microelectronic device according to claim 25, wherein the fiber reinforced encapsulation material includes a polymeric resin selected from epoxy and plastic.

REMARKS

Applicant respectfully asserts that the claims are now in condition for examination. No new matter was added by the presentation of new claims 25-31. Support for new claim 25 comes from page 10, line 14 *et seq.*, FIG. 11, and throughout the specification. Support for new claim 26 comes from page 10, line 14 *et seq.*, FIG. 11, and throughout the specification. Support for new claim 27 comes from page 10, line 14 *et seq.*, FIG. 11, and throughout the specification. Support for new claim 28 comes from page 10, line 14 *et seq.*, FIG. 11, and throughout the specification. Support for new claim 29 comes from page 6, line 10 *et seq.*, page 10, line 14 *et seq.*, FIG. 11, and throughout the specification. Support for new claim 30 comes from page 6, line 10 *et seq.*, page 10, line 14 *et seq.*, FIG. 11, and throughout the specification. Support for new claim 31 comes from pages 3-6, and throughout the specification.

The Examiner is invited to contact Applicant's Representative John Greaves at 801/278-9171 or the below signed attorney if there are any questions regarding this Response or if prosecution of this application may be assisted thereby.

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Title: POLYMERIC ENCAPSULATION MATERIAL WITH FIBROUS FILLER FOR USE IN MICROELECTRONIC CIRCUIT
PACKAGING

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner of Patents, Washington, D.C. 20231, on this 25 day of October, 2002.

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Signature